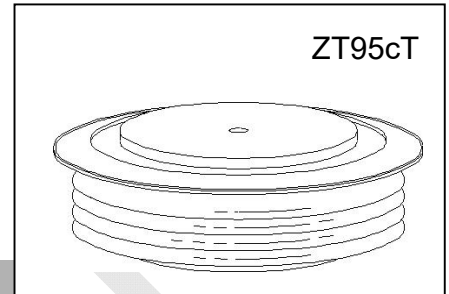




HIGH POWER FREE FLOATING TYPE RECTIFIER DIODE

Features:

- . Free-floating silicon technology
- . Low on-state and switching losses
- . Blocking capability up to 5600 volts
- . Optimum power handling capability
- . Pressure assembled device



ELECTRICAL CHARACTERISTICS AND RATINGS

Reverse Blocking

Device Type	V _{RRM} (1)	V _{RSM} (1)
ZP3500-44	4400	4600
ZP3500-48	4800	5000
ZP3500-52	5200	5400
ZP3500-56	5600	5800

V_{RRM} = Repetitive peak reverse voltage

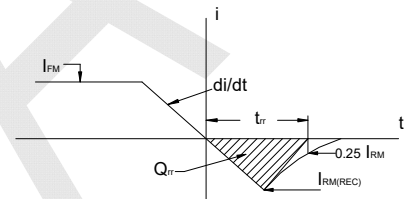
V_{RSM} = Non repetitive peak reverse voltage (2)

Repetitive peak reverse leakage current	I _{RRM}	5 mA 50 mA (3)
---	------------------	-------------------

Notes:

All ratings are specified for T_j=25 °C, unless otherwise stated

- (1) All voltage ratings are specified for an applied 50Hz/60zHz sinusoidal waveform over the temperature range 0 to +150 °C.
- (2) 10 msec. max. pulse width
- (3) Maximum value for T_j = 150 °C.
- (4) See parameter definition below :



REVERSE RECOVERY CHARACTERISTIC

Conducting - on state

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average forward current	I _{F(AV)}		3500		A	Sinewave 180°, T _c =85 °C
RMS forward current	I _{FRMS}		5495		A	Nominal value
Peak one cycle surge (non repetitive) current	I _{FSM}		52000		A	10 msec (50Hz), sinusoidal wave-shape, 180° conduction, T _j = 150 °C
I square t	I ² t		1.3 × 10 ⁷		A ² s	10 msec
Peak forward voltage	V _{FM}		1.30		V	I _{FM} = 3000A; T _j =25 °C
Threshold voltage	V _{FO}		0.90		V	T _j =150 °C, I=0.5 π I _{F(AV)} to 1.5 π I _{F(AV)}
Slope resistance	r _F		0.12		mΩ	T _j =150 °C, I=0.5 π I _{F(AV)} to 1.5 π I _{F(AV)}
Reverse Recovery Current (4)	I _{RM(REC)}				A	I _{FM} = 500 A; di/dt = -10 A/s; T _j max
Reverse Recovery Charge (4)	Q _{rr}				μC	I _{FM} = 500 A; di/dt = -10 A/s; T _j max
Reverse Recovery Time (4)	t _{rr}				μs	I _{FM} = 500 A; di/dt = -10 A/s; T _j max

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T_j	-40	+150		°C	
Storage temperature	T_{stg}	-40	+150		°C	
Thermal resistance - junction to case	$R_{\Theta(j-c)}$		0.008		°C/W	Double sided cooled
Thermal resistance - case to heatsink	$R_{\Theta(c-s)}$		0.002		°C/W	Double sided cooled
Mounting force	P			70	kN	
Weight	W			1.45	kg.	

* Mounting surfaces smooth, flat and greaseless

CASE OUTLINE AND DIMENSIONS

